

N-Channel 30-V (D-S) MOSFET

Description

These miniature surface mount MOSFETs utilize High Cell Density process. Low rDS(on) assures minimal power loss and conserves energy, making this device ideal for use in power management circuitry. Typical applications are lower voltage application, power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

Features

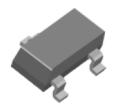
- · Low rDS(on) trench technology
- · Low thermal impedance
- · Fast switching speed
- · RoHS compliant package

Typical Applications:

- · White LED boost converters
- · Automotive Systems
- · Industrial DC/DC Conversion Circuits

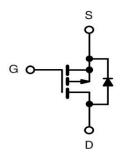
Packing & Order Information

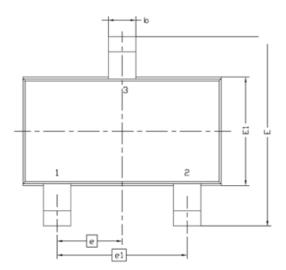
3,000/Reel

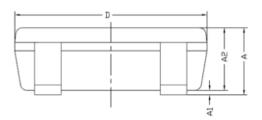


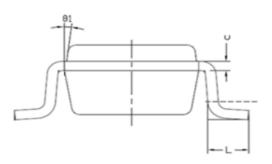
RoHS COMPLIANT

Graphic symbol









Symbol	MILLIMETERS			
Symbol	MIN	MAX		
Α	8.0	1.2		
A1	0	0.1		
A2	0.7	1.1		
b	0.3	0.5		
С	0.1	0.2		
D	2.7	3.1		
Е	2.6	3		
E1	1.4	1.8		
е	0.95 BSC			
e1	1.9 BSC			
L	0.3	0.6		
θ1	7° NOM			



N-Channel 30-V (D-S) MOSFET

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings (Tc=25°C unless otherwise specified)					
Symbol	Parameter	Value	Unit		
V_{DS}	Drain-Source Voltage	30	V		
V _{GS}	Gate-Source Voltage	±20	V		
I _D	Continuous Drain Current ^a (T _A =25°C)	2.4	Α		
	Continuous Drain Current ^a (T _A =70°C)	1.9	Α		
I _{DM}	Pulsed Drain Current ^b	10	Α		
Is	Continuous Source Current (Diode Conduction) ^a	1.9	А		
P _D	Power Dissipation ^a (T _A =25°C)	1.3	W		
	Power Dissipation ^a (T _A =70°C)	0.8	W		
T _J /T _{STG}	Operating Junction and Storage Temperature	-55 to +150	°C		

Thermal Resistance Ratings					
Symbol	Parameter	Maximum	Units		
$R_{ heta JA}$	Maximum Junction-to-Ambient C/W ^a (t <= 10 sec)	100	°C/W		
	Maximum Junction-to-Ambient C/W ^a (Steady-State)	166	C/VV		

Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature

Electrical Characteristics						
Symbol	Parameter	Test Conditions	Min	Тур.	Max.	Units
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	1			V
I _{GSS}	Gate-Body Leakage	$V_{DS} = 0 \text{ V}$, $V_{GS} = \pm 20 \text{ V}$			±100	nA
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$			1 25	uA
I _{D(on)}	On-State Drain Current ^A	V _{DS} = 5 V , V _{GS} = 10 V	5			Α
r DS(on)	Drain-Source On-Resistance ^A	$V_{DS} = 10 \text{ V}, I_{D} = 1.9 \text{ A}$ $V_{DS} = 4.5 \text{ V}, I_{D} = 1.6 \text{ A}$			160 250	mΩ
g fs	Forward Tranconductance ^A	V _{GS} = 15 V, I _D = 1.9 A		6		S
V_{SD}	Diode Forward Voltage	I _S = 0.95 A , V _{GS} = 0 V		0.84		V



N-Channel 30-V (D-S) MOSFET

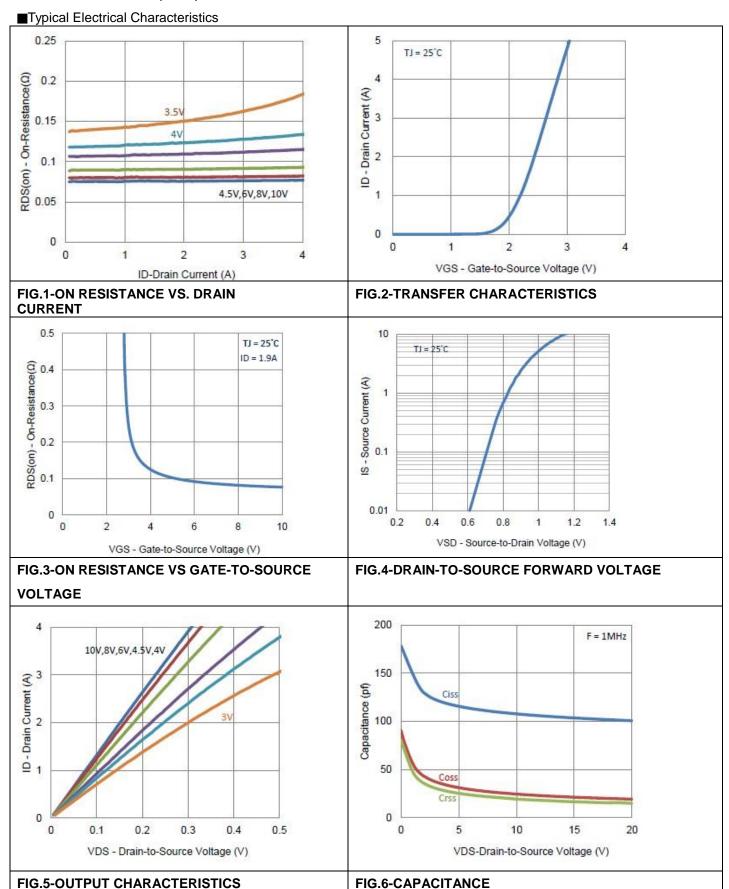
Dynamic ^b						
Symbol	Parameter	Test Conditions	Min	Тур.	Max.	Units
Q_g	Total Gate Charge	$V_{DS} = 15 \text{ V}, I_{D} = 1.9 \text{ A},$ $V_{GS} = 4.5 \text{ V}$		1.4		nC
Q _{gs}	Gate-Source Charge			0.4		nC
Q_{gd}	Gate-Drain Charge			0.7		nC
t _{d(on)}	Turn-On Delay Time	$V_{DS} = 15 \text{ V}, I_{D} = 1.9 \text{ A},$ $V_{GEN} = 10 \text{ V}, R_{L} = 7.9 \Omega,$ $R_{GEN} = 6 \Omega$		2		ns
t _r	Rise Time			5		ns
$t_{d(off)}$	Turn-Off Delay Time			12		ns
tf	Fall Time			4		ns
C _{ISS}	Input Capacitance	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V},$ f =1.0MHz		103		pF
Coss	Output Capacitance			21		pF
C _{RSS}	Reverse Transfer Capacitance			16		pF

Notes

- a. Pulse test: PW <= 300us duty cycle <= 2%.
- b. Guaranteed by design, not subject to production testing.



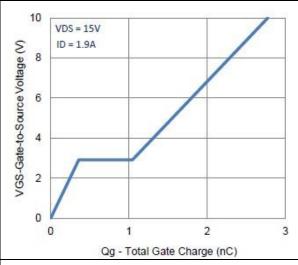
N-Channel 30-V (D-S) MOSFET





N-Channel 30-V (D-S) MOSFET

■Typical Electrical Characteristics



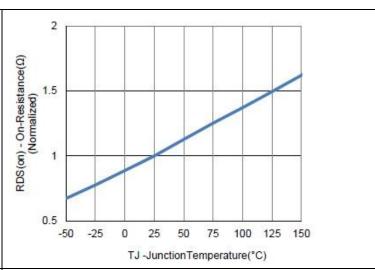


FIG.7-GAGE CHARGE

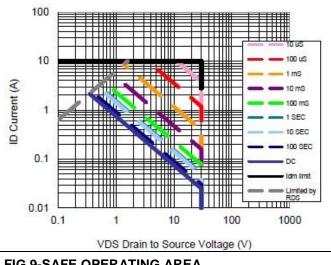


FIG.8-NORMALIZED ON-RESISTANCE VS JUNCTION TMPERATURE

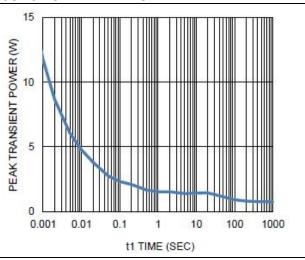


FIG.9-SAFE OPERATING AREA



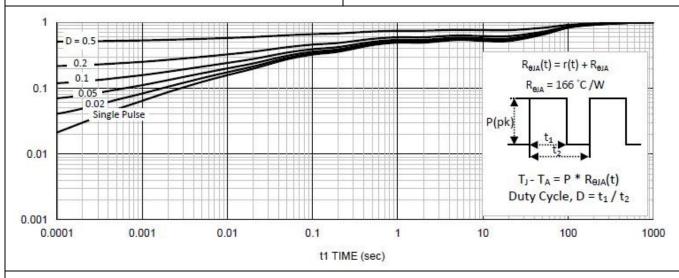


FIG.11-NORMALIZED THERMAL TRANSIENT JUNCTION TO AMBIENT



N-Channel 30-V (D-S) MOSFET

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE. Bruckewell Technology Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Bruckewell"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product. Bruckewell makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Bruckewell disclaims

- (i) Any and all liability arising out of the application or use of any product.
- (ii) Any and all liability, including without limitation special, consequential or incidental damages.
- (iii) Any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Bruckewell's knowledge of typical requirements that are often placed on Bruckewell products in generic applications.

Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time.

Product specifications do not expand or otherwise modify Bruckewell's terms and conditions of purchase, including but not limited to the warranty expressed therein.